

Keysight HMMC-5623

DC to 12 GHz Packaged High Efficiency Divide-by-8 Prescaler

HMMC-5623-TR1-7" diameter reel/500 each

HMMC-5623-BLK-bubble strip/10 each



[Data Sheet](#)

Features

- Wide frequency range:
0.2 - 12 GHz
- High input power sensitivity:
On-chip pre- and post-amps
-15 to +10 dBm (1 - 8 GHz)
-10 to +8 dBm (8 - 10 GHz)
-5 to +2 dBm (10 - 12 GHz)
- P_{out} : 0 dBm (0.5 V_{p-p})
- Low phase noise:
-153 dBc/Hz @ 100 kHz offset
- (+) or (-) Single supply bias operation
- Wide bias supply range:
4.5 to 6.5 volt operating range
- Differential I/O with on-chip
50 Ω matching

Description

The HMMC-5623 is a packaged pre-scaler which offers DC to 12 GHz frequency translation for use in communications and EW systems incorporating high-frequency PLL oscillator circuits and signal-path down conversion applications. It is fabricated using the Keysight Technologies, Inc. InGaP/GaAs HBT MMIC process.

Absolute maximum ratings¹

(@ $T_A = 25^\circ\text{C}$, unless otherwise indicated)

Symbol	Parameters/conditions	Min	Max	Units
V_{CC}	Bias supply voltage		+7	volts
V_{EE}	Bias supply voltage	-7		volts
$V_{CC}-V_{EE}$	Bias supply delta		+7	volts
V_{Logic}	Logic threshold voltage	$V_{CC} - 1.5$	$V_{CC} - 1.2$	volts
$P_{in(CW)}$	CW RF input power		+10	dBm
V_{RFIn}	DC input voltage (@ RF_{in} or RF_{in} ports)		$V_{CC} \pm 0.5$	volts
T_{op}^2	Backside ambient temperature	-40	+85	$^\circ\text{C}$
T_{st}	Storage temperature	-65	+165	$^\circ\text{C}$
T_{max}	Max. assembly temperature (60 s max.)		310	$^\circ\text{C}$

1. Operation in excess of any parameter limit (except T_{op}) may cause permanent damage to the device.
2. $MTTF > 1 \times 10^6$ hours @ $T_{op} \leq 85^\circ\text{C}$. Operation in excess of maximum operating temperature (T_{op}) will degrade MTTF.

DC specifications/physical properties¹

($T_A = 25^\circ\text{C}$, $V_{CC} - V_{EE} = 5.0$ volts, unless otherwise listed)

Symbol	Parameters/conditions	Min	Typ	Max	Units
$V_{CC} - V_{EE}$	Operating bias supply difference ¹	4.5	5.0	6.5	Volts
$ I_{CC} $ or $ I_{EE} $	Bias supply current	34	40	46	mA
$V_{RFIn(q)}, V_{RFout(q)}$	Quiescent dc voltage appearing at all RF ports		V_{CC}		Volts
V_{Logic}	Nominal ECL logic level (V_{Logic} contact self-bias voltage, generated on-chip)	$V_{CC} - 1.45$	$V_{CC} - 1.35$	$V_{CC} - 1.25$	Volts

1. Prescaler will operate over full specified supply voltage range, V_{CC} or V_{EE} not to exceed limits specified in *Absolute maximum ratings* section.



- Package type: quad flat - no pins (SMT QFN)
- Package dimensions: 3 x 3 mm (0.118 x 0.118 in)
- Package thickness: 0.90 ±0.10 mm (0.035 ±0.0039 in)
- Pin pitch: 0.5 mm (0.0197 in)
- Pin width: 0.20 mm (0.008 in)

RF specifications

($T_A = 25\text{ }^\circ\text{C}$, $Z_0 = 50\ \Omega$, $V_{CC} - V_{EE} = 5.0\text{ volts}$)

Symbol	Parameters/conditions	Min	Typ	Max	Units
$f_{in(max)}$	Maximum input frequency of operation	12	14		GHz
$f_{in(min)}$	Minimum input frequency of operation ¹ ($P_{in} = -10\text{ dBm}$)		0.2	0.5	GHz
$f_{Self-Osc.}$	Output self-oscillation frequency ²		3.4		GHz
P_{in}	@ dc (Square-wave input)	-15	> -25	+10	dBm
	@ $f_{in} = 500\text{ MHz}$ (Sine-wave input)	-15	> -20	+10	dBm
	$f_{in} = 1\text{ to }8\text{ GHz}$	-15	> -20	+10	dBm
	$f_{in} = 8\text{ to }10\text{ GHz}$	-10	> -15	+5	dBm
	$f_{in} = 10\text{ to }12\text{ GHz}$	-5	> -10	-1	dBm
RL	Small-signal input/output return loss (@ $f_{in} < 10\text{ GHz}$)		15		dB
S_{12}	Small-signal reverse isolation (@ $f_{in} < 10\text{ GHz}$)		30		dB
ϕ_N	SSB phase noise (@ $P_{in} = 0\text{ dBm}$, 100 kHz offset from a $f_{out} = 1.2\text{ GHz}$ carrier)		-153		dBc/Hz
Jitter	Input signal time variation @ zero-crossing ($f_{in} = 10\text{ GHz}$, $P_{in} = -10\text{ dBm}$)		1		ps
T_r or T_f	Output transition time (10% to 90% rise/fall time)		70		ps
P_{out}^3	@ $f_{out} < 1\text{ GHz}$	-2.0	0		dBm
	@ $f_{out} = 2.5\text{ GHz}$	-3.5	-1.5		dBm
	@ $f_{out} = 3.0\text{ GHz}$	-4.5	-2.5		dBm
$ V_{out(p-p)} ^4$	@ $f_{out} < 1\text{ GHz}$		0.5		Volts
	@ $f_{out} = 2.5\text{ GHz}$		0.42		Volts
	@ $f_{out} = 3.0\text{ GHz}$		0.37		Volts
$P_{Spitback}$	f_{out} power level appearing at RF_{in} or \overline{RF}_{in} (@ $f_{in} = 10\text{ GHz}$, unused RF_{out} or \overline{RF}_{out} unterminated)		-50		dBm
	f_{out} power level appearing at RF_{in} or \overline{RF}_{in} (@ $f_{in} = 10\text{ GHz}$, both RF_{out} and \overline{RF}_{out} terminated)		-55		dBm
$P_{feedthru}$	Power level of f_{in} appearing at RF_{out} or \overline{RF}_{out} (@ $f_{in} = 12\text{ GHz}$, $P_{in} = 0\text{ dBm}$, referred to $P_{in}(f_{in})$)		-30		dBc
H_2	Second harmonic distortion output level (@ $f_{out} = 3.0\text{ GHz}$, referred to $P_{out}(f_{out})$)		-25		dBc

1. For sine-wave input signal. Prescaler will operate down to D.C. for square-wave input signal. Minimum divide frequency limited by input slew-rate.
2. Prescaler may exhibit this output signal under bias in the absence of an RF input signal. This condition may be eliminated by use of the Input dc offset technique described on page 4.
3. Fundamental of output square wave's Fourier Series.
4. Square wave amplitude calculated from P_{out} .

Applications

The 1GC1-4267 is designed for use in high frequency communications, microwave instrumentation, and EW radar systems where low phase-noise PLL control circuitry or broad-band frequency translation is required.

Operation

The device is designed to operate when driven with either a single-ended or differential sinusoidal input signal over a 200 MHz to 12 GHz bandwidth. Below 200 MHz the prescaler input is “slew-rate” limited, requiring fast rising and falling edge speeds to properly divide. The device will operate at frequencies down to dc when driven with a square-wave.

Due to the presence of an off-chip RF-bypass capacitor inside the package (connected to the V_{CC} contact on the device), and the unique design of the device itself, the component may be biased from either a single positive or single negative supply bias. The backside of the package is not dc connected to any dc bias point on the device.

For positive supply operation, V_{CC} pins are nominally biased at any voltage in the +4.5 to +6.5 volt range with pin 8 (V_{EE}) grounded. For negative bias operation V_{CC} pins are typically grounded and a negative voltage between -4.5 to -6.5 volts is applied to pin 8 (V_{EE}).

AC-Coupling and DC-Blocking

All RF ports are dc connected on-chip to the V_{CC} contact through on-chip $50\ \Omega$ resistors. Under any bias conditions where V_{CC} is not dc grounded the RF ports should be ac coupled via series capacitors mounted on the PC-board at each RF port. Only under bias conditions where V_{CC} is dc grounded (as is typical for negative bias supply operation) may the RF ports be direct coupled to adjacent circuitry or in some cases, such as level shifting to subsequent stages. In the latter case the package heat sink may be “floated” and bias applied as the difference between V_{CC} and V_{EE} .

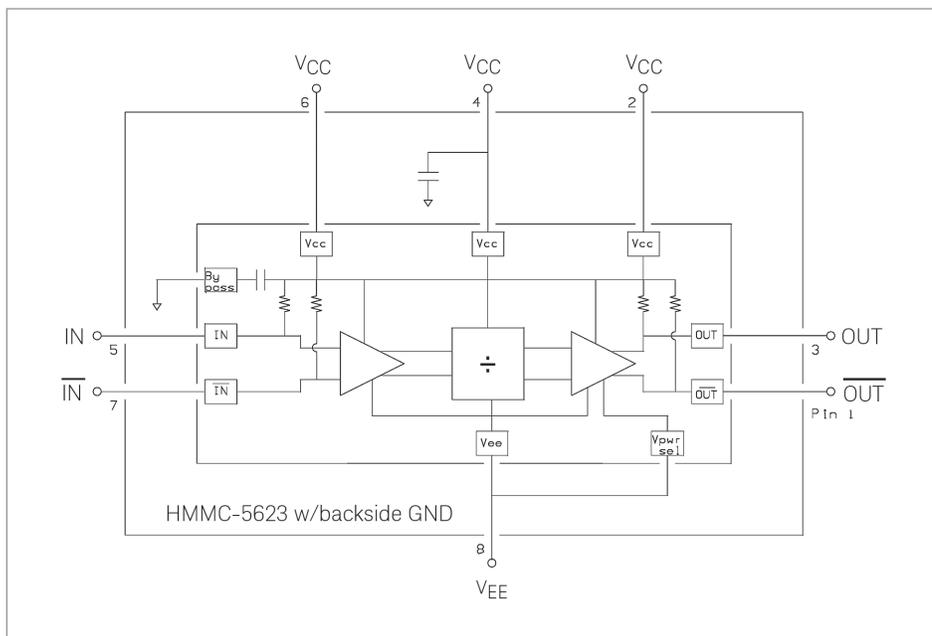


Figure 1. Simplified schematic diagram

Input DC Offset

If an RF signal with sufficient signal to noise ratio is present at the RF input lead, the prescaler will operate and provide a divided output equal the input frequency divided by the divide modulus. Under certain “ideal” conditions where the input is well matched at the right input frequency, the component may “self-oscillate”, especially under small signal input powers or with only noise present at the input. This “self-oscillation” will produce a undesired output signal also known as a false trigger. To prevent false triggers or self-oscillation conditions, apply a 20 to 100 mV dc offset voltage between the RF_{in} and RF_{in} ports. This prevents noise or spurious low level signals from triggering the divider.

Adding a 10 k Ω resistor between the unused RF input to a contact point at the V_{EE} potential will result in an offset of ≈ 25 mV between the RF inputs. Note however, that the input sensitivity will be reduced slightly due to the presence of this offset.

Assembly Notes

Independent of the bias applied to the package, the backside of the package should always be connected to both a good RF ground plane and a good thermal heat sinking region on the PC board to optimize performance. For single-ended output operation the unused RF output lead should be terminated into 50 Ω to a contact point at the VCC potential or to RF ground through a dc blocking capacitor.

A minimum RF and thermal PC board contact area equal to or greater than 2.67×1.65 mm ($0.105'' \times 0.065''$) with eight 0.020" diameter plated-wall thermal vias is recommended.

MMIC ESD precautions, handling considerations, die attach and bonding methods are critical factors in successful GaAs MMIC performance and reliability.

Keysight Technologies GaAs MMIC ESD, Die Attach and Bonding Guidelines - Application Note, literature number 5991-3484EN provides basic information on these subjects.

Moisture Sensitivity Classification: Class 5A, per JESD22-A112-A.

Additional References

Keysight Technologies HBT Prescaler Evaluation Board - Technical Overview, literature number 5991-3578EN.

RoHS Compliance

This device is RoHS Compliant. This means the component meets the requirements of the European Parliament and the Council of the European Union *Restriction of Hazardous Substances* Directive 2011/65/EU, commonly known as *RoHS*. The six regulated substances are lead, mercury, cadmium, chromium VI (hexavalent), polybrominated biphenyls (PBB) and polybrominated biphenyl ethers (PBDE). RoHS compliance implies that any residual concentration of these substances is below the RoHS Directive's maximum concentration values (MVC); being less than 1000 ppm by weight for all substances except for cadmium which is less than 100 ppm by weight.

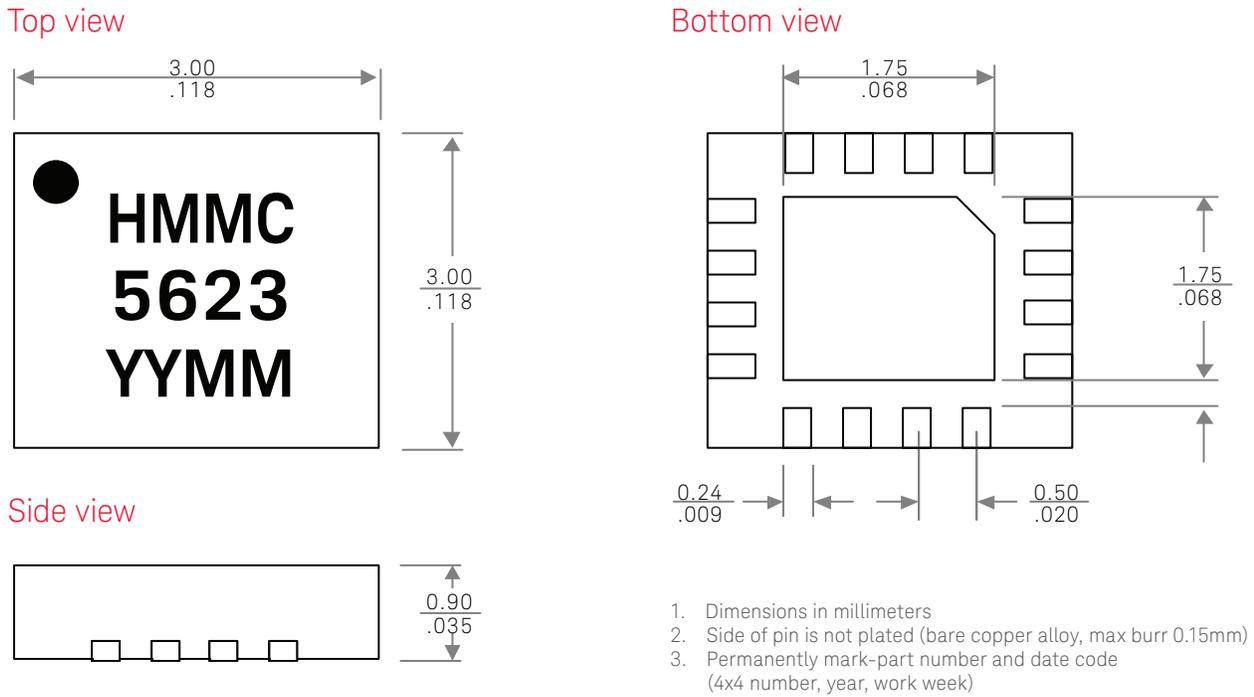


Figure 2. Package and dimensions

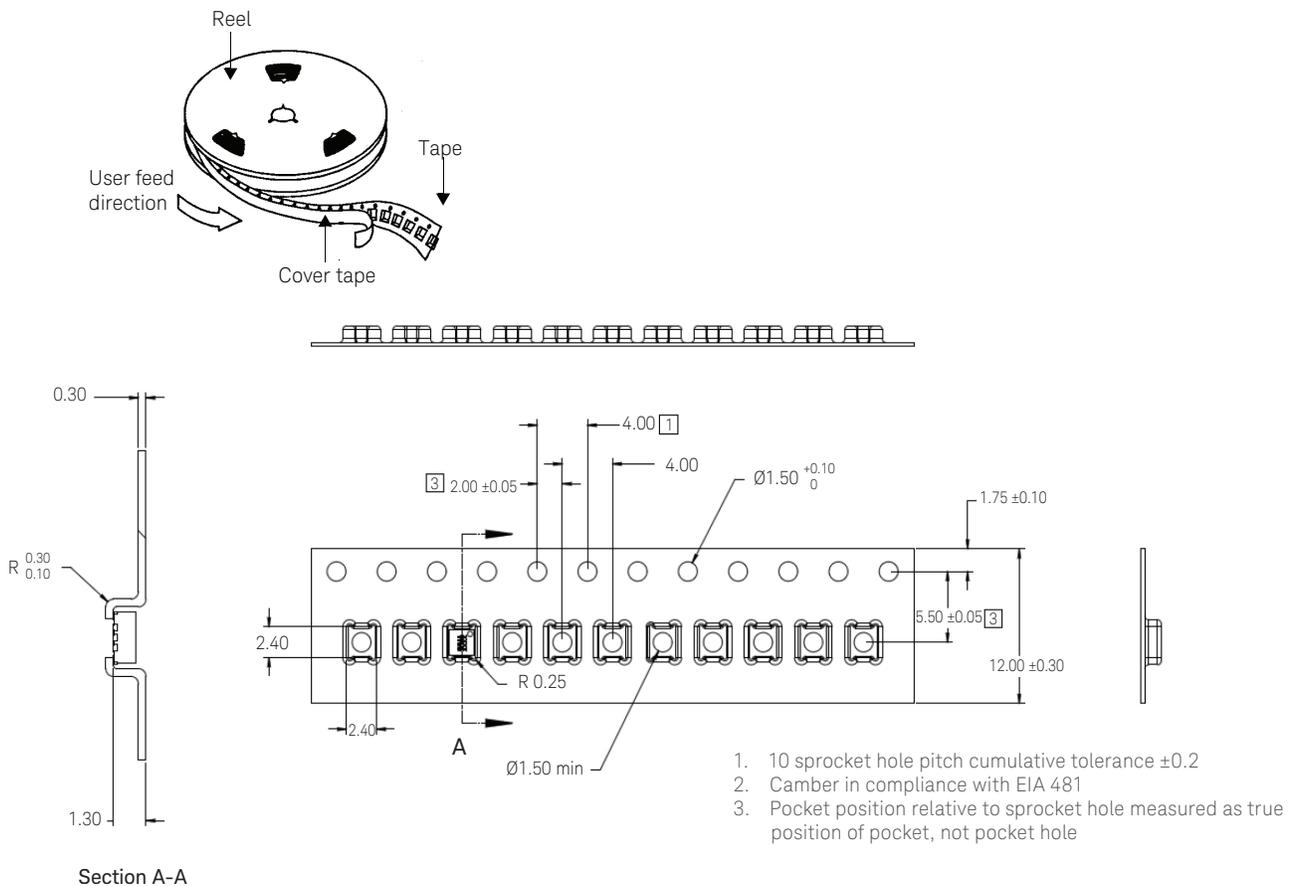


Figure 3. Assembly diagram (single-supply, positive-bias configuration shown)

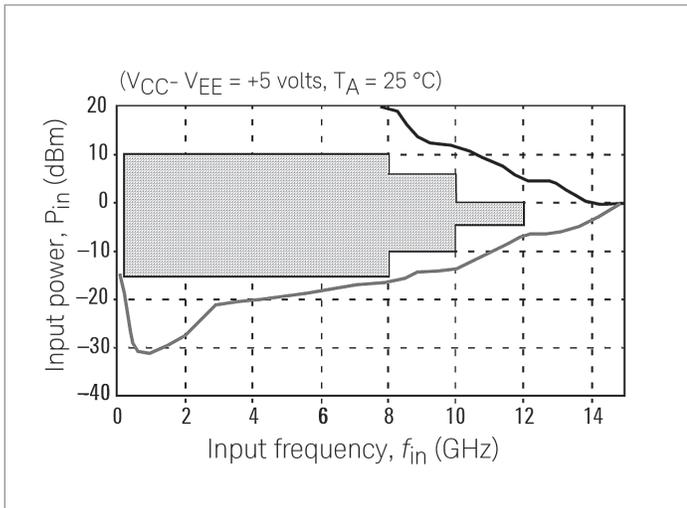


Figure 4. Typical input sensitivity window

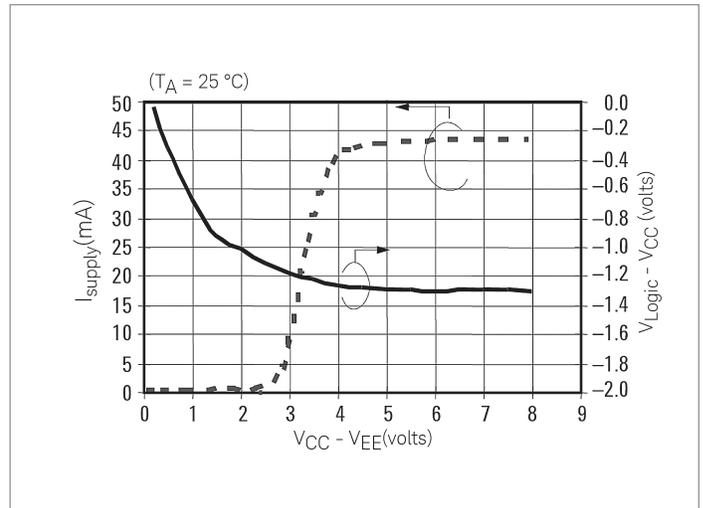


Figure 5. Typical supply current & V_{Logic} vs. supply voltage

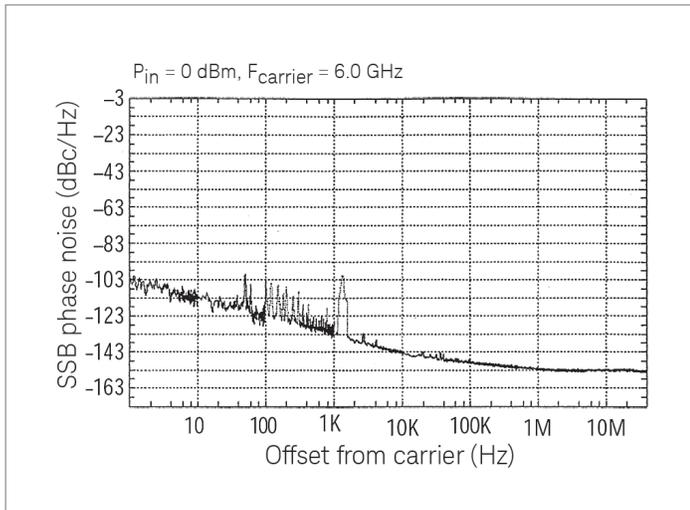


Figure 6. Typical phase noise performance

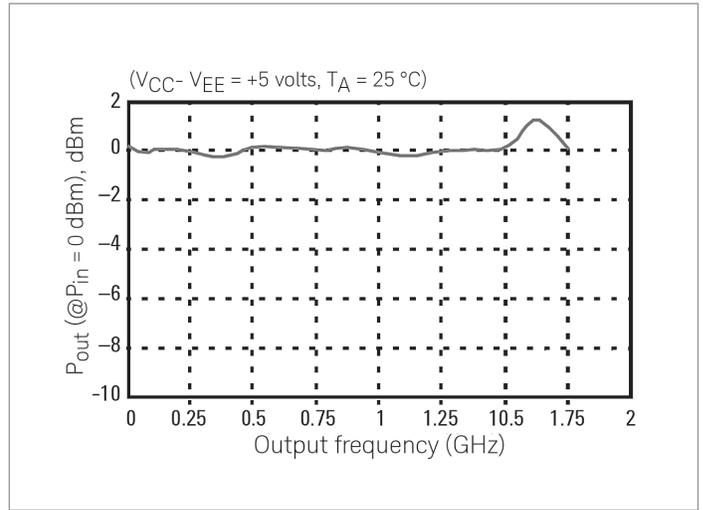


Figure 7. Typical output power vs. output frequency, f_{out} (GHz)

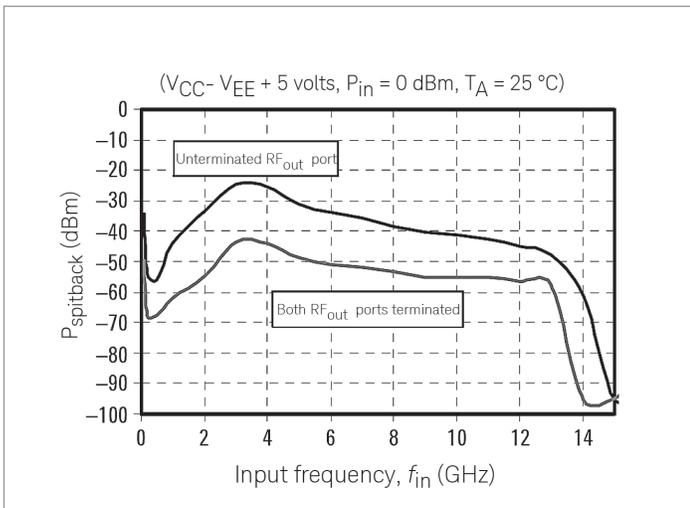


Figure 8. Typical "Spitback" power $P(f_{out})$ appearing at RF input port

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The product described in this data sheet is **RoHS Compliant** and **RoHS Process Compatible** with a maximum temperature of 260 °C and a maximum of 3 temperature cycles.

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